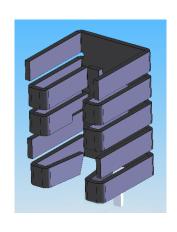
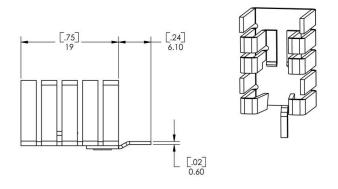
T0-220, T0-262

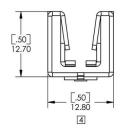
Board Level Heat Sinks

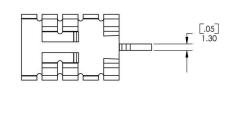


P/N: 831302B00000









PRODUCT SPECIFICATIONS-

Devices: TO-220 & TO-262Size: 19.0 x 12.8 x 12.7 mm

Material: Aluminum, 1.2 mm Thick

Type: Stamped

IC Mounting: Integrated SpringPCB Mounting: Solderable Tab

• Finish: Black Anodized

· Package: Bulk

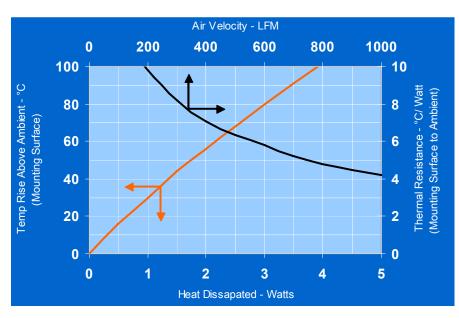
FEATURES & BENEFITS

- No Hardware Device Attachment
- Constant Spring Force Tension
- Vertical Mounting via Solderable Tab
- RoHS Compliant



CUSTOMIZED HEATSINKS

- Specialized Tabs, Plating
- Specialized Body Configurations
- Contact Applications Engineering



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